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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of:

Applicant(s): Jagrut Viliskumar Patel

Serial No: 10/750,342

Filing Date: December 31, 2003

Examiner: Aditya S. Bhat

Art Unit: 2863

Conf. No: 9469

Title: IDENTIFYING PROCESS AND TEMPERATURE OF SILICON CHIPS

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

SUPPLEMENTAL AMENDMENT

Dear Commissioner:

This paper is submitted as a supplement to the response filed August 7, 2008 to the Non-Final Rejection dated April 8, 2008. Please enter the following amendments and consider the following remarks.

Amendments to the Specification begin on page 2 of this paper.

Remarks begin on page 3.

CERTIFICATE OF TRANSMISSION (37 CFR 1.8(a))
ELECTRONIC FILING

I hereby certify that this correspondence is being transmitted electronically to the United States Patent and Trademark Office on November 20, 2008.

Depositor's Name: **Gavle Gestick**
(Typed name)

Signature: /Gayle Gestick/

Date: November 20, 2008